





QUAD SURFACE MOUNT SWITCHING DIODE ARRAY

Features

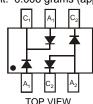
- Fast Switching Speed
- Ultra-Small Surface Mount Package
- For General Purpose Switching Applications
- High Conductance
- One BAV70 Circuit and One BAW56 Circuit In One Package
- Easily Connected As Full Wave Bridge
- Lead Free/RoHS Compliant (Note 3)
- "Green" Device (Notes 4 and 5)

Mechanical Data

- Case: SOT-363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: See Diagram
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.006 grams (approximate)







Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage	V_{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _R WM V _R	75	V
RMS Reverse Voltage	V _{R(RMS)}	53	V
Forward Continuous Current (Notes 1 and 2)	I _{FM}	300	mA
Average Rectified Output Current (Notes 1 and 2)	lo	150	mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0μs @ t = 1.0s	I _{FSM}	2.0 1.0	А

Thermal Characteristics

			,
Characteristic	Symbol	Value	Unit
Power Dissipation (Notes 1 and 2)	P_{D}	200	mW
Power Dissipation T _S = 60°C (Note 2)	P _D	300	mW
Thermal Resistance Junction to Ambient Air (Notes 1 and 2)	$R_{ hetaJA}$	625	°C/W
Thermal Resistance Junction to Soldering Point (Note 2)	$R_{ heta JS}$	275	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

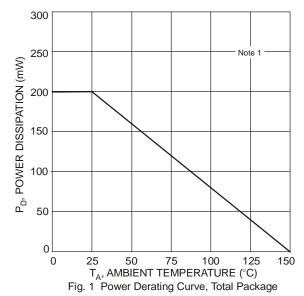
Electrical Characteristics @T_A = 25°C unless otherwise specified

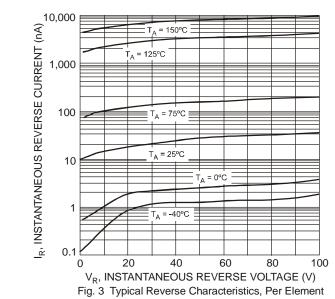
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	75	_	V	$I_R = 2.5 \mu A$
Forward Voltage	VF		0.715 0.855 1.0 1.25	V	I _F = 1.0mA I _F = 10mA I _F = 50mA I _F = 150mA
Reverse Current (Note 6)	I _R	l	2.5 50 30 25	μΑ μΑ μΑ nA	$V_R = 75V$ $V_R = 75V$, $T_J = 150$ °C $V_R = 25V$, $T_J = 150$ °C $V_R = 20V$
Total Capacitance	Ст	_	2.0	pF	$V_R = 0, f = 1.0MHz$
Reverse Recovery Time	t _{rr}	_	4.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$

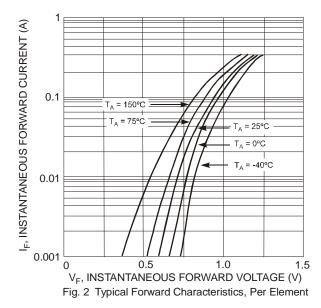
Notes:

- Device mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- One or more diodes loaded.
- No purposefully added lead.
- Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
- Product manufactured with Date Code UO (week 40, 2007) and newer are built with Green Molding Compound. Product manufactured prior to Date $\label{local_control$
- 6. Short duration pulse test used to minimize self-heating effect.









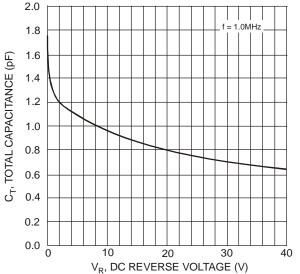


Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

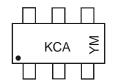
Ordering Information (Notes 5 & 7)

Part Number	Case	Packaging
BAV756DW-7-F	SOT-363	3000/Tape & Reel

Notes:

7. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



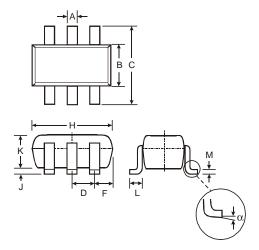
KCA = Product Type Marking Code YM = Date Code Marking Y = Year ex: N = 2002 M = Month ex: 9 = September

Date Code Key

Year	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2111	2012
Code	М	N	Р	R	S	Т	U	V	W	Х	Υ	Z
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec

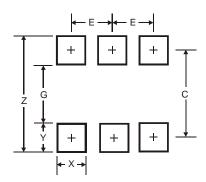


Package Outline Dimensions



SOT-363					
Dim	Min	Max			
Α	0.10	0.30			
В	1.15	1.35			
С	2.00	2.20			
D	0.65 Nominal				
F	0.30	0.40			
Н	1.80	2.20			
J		0.10			
K	0.90	1.00			
L	0.25	0.40			
М	0.10	0.25			
α	0°	8°			
All Di	All Dimensions in mm				

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.5
G	1.3
X	0.42
Υ	0.6
С	1.9
Е	0.65

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